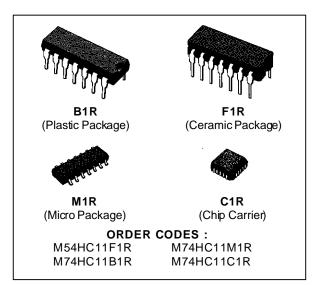


## TRIPLE 3-INPUT AND GATE

- HIGH SPEED
  - $t_{PD} = 7 \text{ ns (TYP.)} AT V_{CC} = 5 \text{ V}$
- LOW POWER DISSIPATION  $I_{CC} = 1 \mu A \text{ (MAX.)} \text{ AT } I_A = 25 \text{ °C}$
- HIGH NOISE IMMUNITY

  VNIH = VNIL = 28 % VCC (MIN.)
- OUTPUT DRIVE CAPABILITY
   10 LSTTL LOADS
- SYMMETRICAL OUTPUT IMPEDANCE | IOH | = I<sub>OL</sub> = 4 mA (MIN.)
- BALANCED PROPAGATION DELAYS

  tplh = tphl
- WIDE OPERATING VOLTAGE RANGE Vcc (OPR) = 2 V TO 6 V
- PIN AND FUNCTION COMPATIBLE WITH 54/74LS11

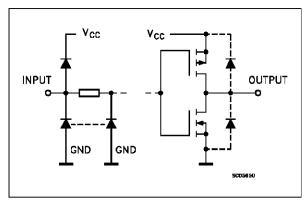


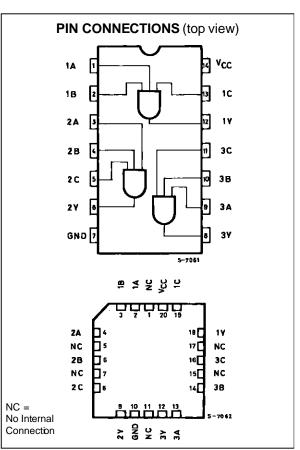
## **DESCRIPTION**

The M54/74HC11 is a high speed CMOS TRIPLE 3-INPUT AND GATE fabricated in silicon gate C<sup>2</sup>MOS technology.

It has the same high speed performance of LSTTL combined with true CMOS low power consumption. The internal circuit is composed of 4 stages including buffered output, which gives high noise immunity and a stable output. All inputs are equipped with protection circuits against static discharge and transient excess voltage.

#### INPUT AND OUTPUT EQUIVALENT CIRCUIT





February 1993

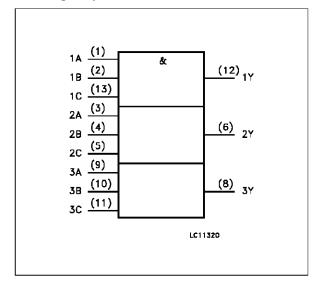
## **TRUTH TABLE**

Α	В	С	Υ
L	X	X	L
X	L	Х	L
Х	Х	L	L
Н	Н	Н	Н

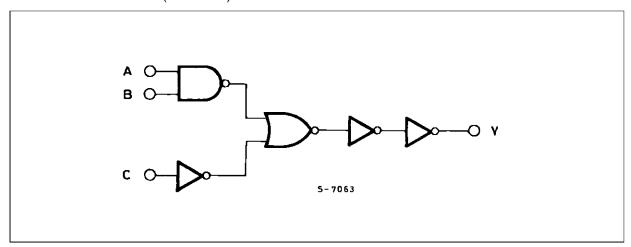
### **PIN DESCRIPTION**

PIN No	SYMBOL	NAME AND FUNCTION
1, 3, 9	1A to 3A	Data Inputs
2, 4, 10	1B to 3B	Data Inputs
13, 5, 11	1C to 3C	Data Inputs
12, 6, 8	1Y to 3Y	Data Outputs
7	GND	Ground (0V)
14	Vcc	Positive Supply Voltage

## **IEC Logic Symbol**



## **SCHEMATIC CIRCUIT** (Per Gate)



### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
Vcc	Supply Voltage	-0.5 to +7	V
VI	DC Input Voltage	-0.5 to V <sub>CC</sub> + 0.5	V
Vo	DC Output Voltage	-0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	DC Input Diode Current	± 20	mA
I <sub>OK</sub>	DC Output Diode Current	± 20	mA
lo	DC Output Source Sink Current Per Output Pin	± 25	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current	± 50	mA
$P_{D}$	Power Dissipation	500 (*)	mW
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
TL	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied. (\*) 500 mW:  $\equiv$  65 °C derate to 300 mW by 10mW/°C: 65 °C to 85 °C



## RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Value	Unit
Vcc	Supply Voltage		2 to 6	V
VI	Input Voltage		0 to V <sub>CC</sub>	V
Vo	Output Voltage		0 to V <sub>CC</sub>	V
Тор	Operating Temperature: <b>M54HC</b> Series <b>M74HC</b> Series		-55 to +125 -40 to +85	သိ ဂ
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Time	V <sub>CC</sub> = 2 V	0 to 1000	ns
		$V_{CC} = 4.5 \text{ V}$	0 to 500	
		V <sub>CC</sub> = 6 V	0 to 400	

## **DC SPECIFICATIONS**

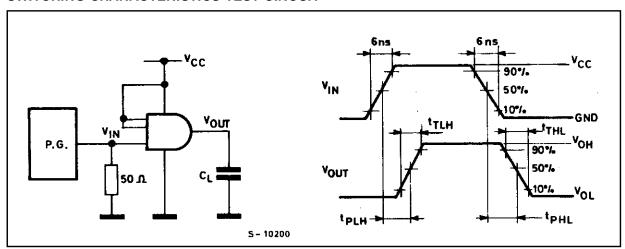
		Test Conditions		Value								
Symbol Parameter	Parameter	V <sub>CC</sub> (V)				<sub>A</sub> = 25 <sup>c</sup> C and 7			85 °C HC	-55 to 54	125 °C HC	Unit
		( )			Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
$V_{IH}$	High Level Input	2.0			1.5			1.5		1.5		
	Voltage	4.5			3.15			3.15		3.15		V
		6.0			4.2			4.2		4.2		
$V_{IL}$	Low Level Input	2.0					0.5		0.5		0.5	
	Voltage	4.5					1.35		1.35		1.35	V
		6.0					1.8		1.8		1.8	
VoH	High Level	2.0	V <sub>I</sub> =	I <sub>O</sub> =-20 μA	1.9	2.0		1.9		1.9		]
	Output Voltage	4.5	VI		4.4	4.5		4.4		4.4		
		6.0	or		5.9	6.0		5.9		5.9		V
		4.5	VIL	I <sub>O</sub> =-4.0 mA	4.18	4.31		4.13		4.10		
		6.0		I <sub>O</sub> =-5.2 mA	5.68	5.8		5.63		5.60		
$V_{OL}$	Low Level Output	2.0	Vı =			0.0	0.1		0.1		0.1	
	Voltage	4.5	VI =	I <sub>O</sub> = 20 μA		0.0	0.1		0.1		0.1	
		6.0	or			0.0	0.1		0.1		0.1	V
		4.5	V <sub>IL</sub>	I <sub>O</sub> = 4.0 mA		0.17	0.26		0.33		0.40	
		6.0		I <sub>O</sub> = 5.2 mA		0.18	0.26		0.33		0.40	
I	Input Leakage Current	6.0	V <sub>I</sub> = '	√cc or GND			±0.1		±1		±1	μΑ
Icc	Quiescent Supply Current	6.0	V <sub>I</sub> = '	Vcc or GND			1		10		20	μΑ

## AC ELECTRICAL CHARACTERISTICS ( $C_L = 50 \text{ pF}$ , Input $t_r = t_f = 6 \text{ ns}$ )

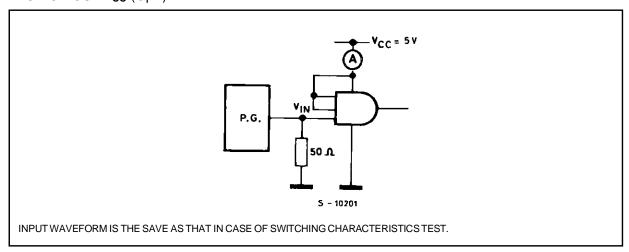
		Test Conditions		Value							
Symbol Parameter	Vcc			T <sub>A</sub> = 25 °C 54HC and 74HC			85 °C HC	-55 to 125 °C 54HC		Unit	
		(V)		Min.	Тур.	Max.	Min.	Max.	Min.	Max.	
$t_{TLH}$	Output Transition	2.0			30	75		95		110	
$t_{THL}$	Time	4.5			8	15		19		22	ns
		6.0			7	13		16		19	
t <sub>PLH</sub>	Propagation	2.0			40	85		105		130	
$t_{PHL}$	Delay Time	4.5			10	17		21		26	ns
		6.0			9	14		18		22	
C <sub>IN</sub>	Input Capacitance				5	10		10		10	pF
C <sub>PD</sub> (*)	Power Dissipation Capacitance				26						pF

<sup>(\*)</sup> C<sub>PD</sub> is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operting current can be obtained by the following equation. I<sub>CC</sub>(opr) = C<sub>PD</sub> • V<sub>CC</sub> • f<sub>IN</sub> + I<sub>CC</sub>/3 (per Gate)

### SWITCHING CHARACTERISTICS TEST CIRCUIT

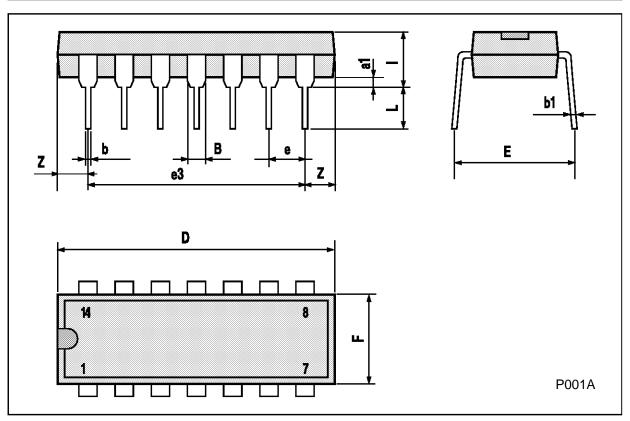


## TEST CIRCUIT ICC (Opr.)



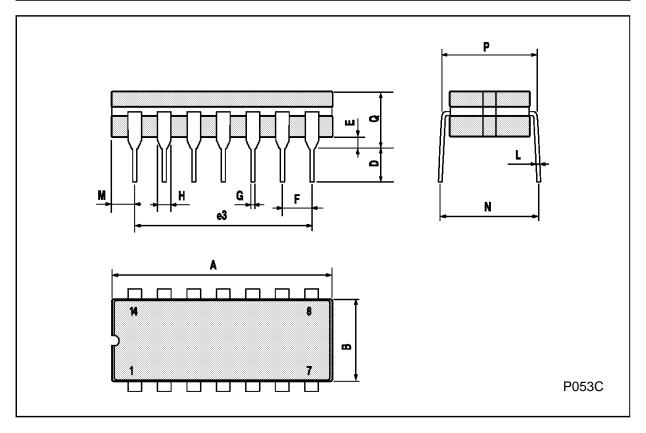
# Plastic DIP14 MECHANICAL DATA

DIM.		mm				
D.141.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
В	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
е		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100



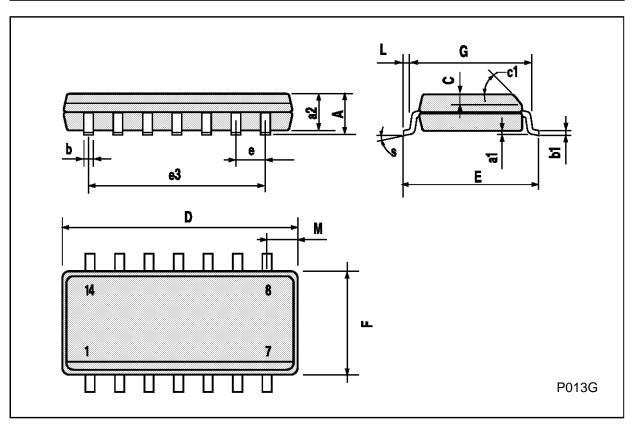
# **Ceramic DIP14/1 MECHANICAL DATA**

DIM.		mm		inch			
Dilli.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А			20			0.787	
В			7.0			0.276	
D		3.3			0.130		
Е	0.38			0.015			
e3		15.24			0.600		
F	2.29		2.79	0.090		0.110	
G	0.4		0.55	0.016		0.022	
Н	1.17		1.52	0.046		0.060	
L	0.22		0.31	0.009		0.012	
М	1.52		2.54	0.060		0.100	
N			10.3			0.406	
Р	7.8		8.05	0.307		0.317	
Q			5.08			0.200	



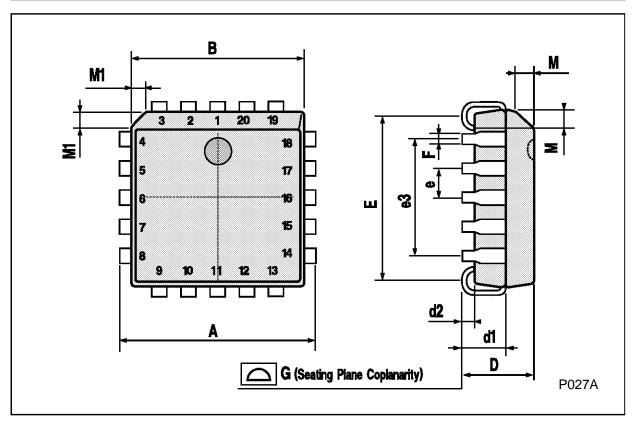
# **SO14 MECHANICAL DATA**

DIM.		mm			inch			
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
Α			1.75			0.068		
a1	0.1		0.2	0.003		0.007		
a2			1.65			0.064		
b	0.35		0.46	0.013		0.018		
b1	0.19		0.25	0.007		0.010		
С		0.5			0.019			
c1			45°	(typ.)				
D	8.55		8.75	0.336		0.344		
Е	5.8		6.2	0.228		0.244		
е		1.27			0.050			
e3		7.62			0.300			
F	3.8		4.0	0.149		0.157		
G	4.6		5.3	0.181		0.208		
L	0.5		1.27	0.019		0.050		
М			0.68			0.026		
S			8° (ı	max.)				



## PLCC20 MECHANICAL DATA

DIM.		mm		inch				
Divi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
А	9.78		10.03	0.385		0.395		
В	8.89		9.04	0.350		0.356		
D	4.2		4.57	0.165		0.180		
d1		2.54			0.100			
d2		0.56			0.022			
E	7.37		8.38	0.290		0.330		
е		1.27			0.050			
e3		5.08			0.200			
F		0.38			0.015			
G			0.101			0.004		
М		1.27			0.050			
M1		1.14			0.045			



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